

20V N-Channel Enhancement Mode MOSFET

MAIN CHARACTERISTICS

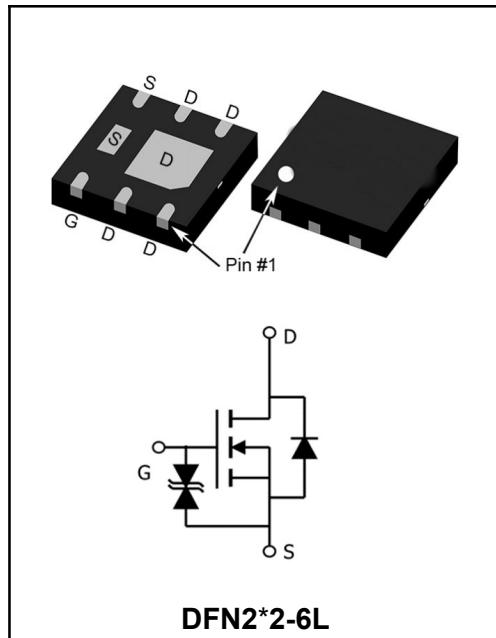
I_D	10A
V_{DSS}	20V
$R_{DS(on)-typ}(@V_{GS}=4.5V)$	<15mΩ(Typ:11.5mΩ)

FEATURES

- Epoxy meets UL-94 V-0 flammability rating and halogen free
- Trench Power LV MOSFET technology
- High Power and current handing capability

APPLICATION

- PWM application
- Load switch



Absolute Maximum Ratings ($T_A=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V_{DS}	20	V
Gate-Source Voltage	V_{GS}	± 12	V
Continuous Drain Current $T_A=25^\circ C$	I_D	10	A
Pulsed Drain Current ⁽²⁾	I_{DM}	40	A
Power Dissipation	P_D	2	W
Storage Temperature Range	T_{STG}	-55 to 150	°C
Operating Junction Temperature Range	T_J	-55 to 150	°C
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	62.5	°C/W

Note:

1. The value of $R_{\theta JA}$ is measured with the device mounted on the 40mm×40mm×1.1mm single layer FR-4 PCB board with 1in2 pad of 2oz. Copper in the still air environment. The maximum allowed junction temperature of 175°C. The value in any given application depends on the user's specific board design.
2. Practically the current is limited by the overall system design including the customer-specific PCB.

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Parameter	Conditions	Symbol	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}$, $I_D=250\mu\text{A}$	$V_{(BR)DSS}$	20	-	-	V
Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250\mu\text{A}$	$V_{GS(\text{th})}$	0.45	0.7	1.0	V
Zero Gate Voltage Drain Current	$V_{GS} = 0\text{V}$, $V_{DS} = 20\text{V}$	I_{DSS}	-	-	1	uA
Gate-Source Leakage Current	$V_{DS}=0\text{V}, V_{GS}=\pm 12\text{V}$	I_{GSS}	-	-	± 10	uA
Static Drain-Source ON-Resistance	$V_{GS} = 4.5\text{V}$, $I_D = 5\text{A}$	$R_{DS(\text{ON})}$	-	11.5	15	m}\Omega
	$V_{GS} = 2.5\text{V}$, $I_D = 3\text{A}$		-	14.5	19	m}\Omega
Source-Drain Voltage	$V_{GS}=0\text{V}; I_F=1\text{A}$	V_{SD}	-	-	1.2	V
Total Gate Charge	$V_{GS}=4.5\text{V}$ $I_D = 4\text{A}$	Q_g	-	3.9	-	nC
Gate Source Charge		Q_{gs}	-	11	-	
Gate Drain Charge		Q_{gd}	-	1.3	-	
Input Capacitance	$V_{DS}=4.5\text{V}$ $V_{GS}=0\text{V}$ $f=1\text{MHz}$	C_{iss}	-	1100	-	pF
Output Capacitance		C_{oss}	-	100	-	
Reverse Transfer Capacitance		C_{rss}	-	2	-	
Turn-On Delay Time	$V_{GS} = 4.5\text{V}$ $V_{DD} = 20\text{V}$ $I_D = 3.5\text{A}$ $R_G = 3\Omega$	$T_{d(on)}$	-	10.6	-	ns
Rise Time		T_r	-	6	-	
Turn-Off Delay Time		$T_{d(off)}$	-	27.4	-	
Fall Time		T_f	-	7	-	

Ratings And Characteristic Curves

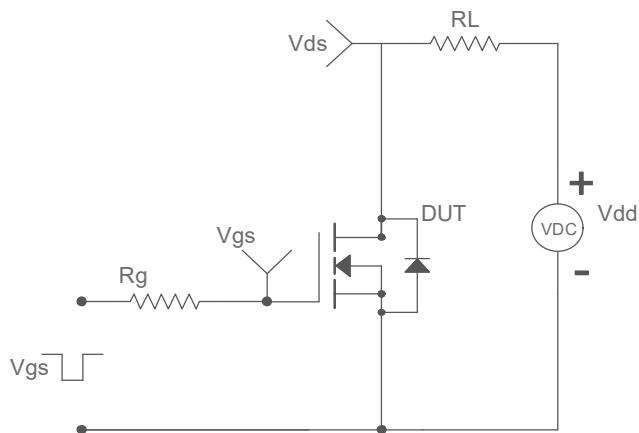


Figure 1 Switching Test Circuit

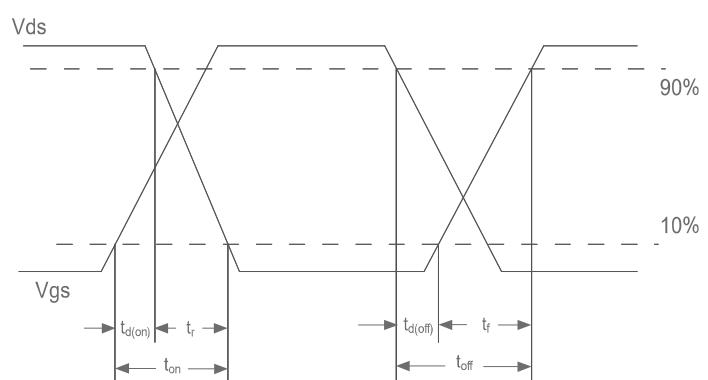
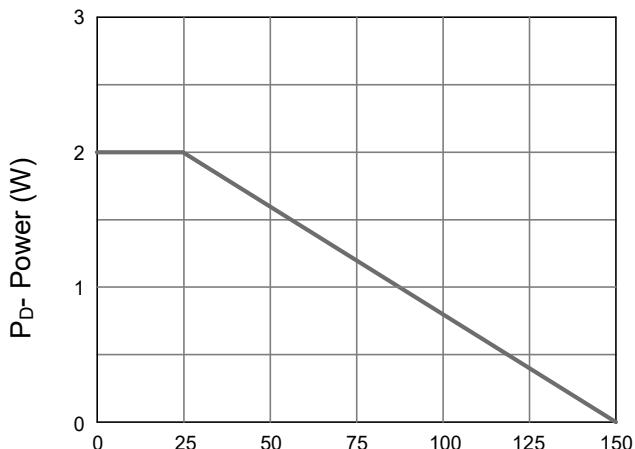
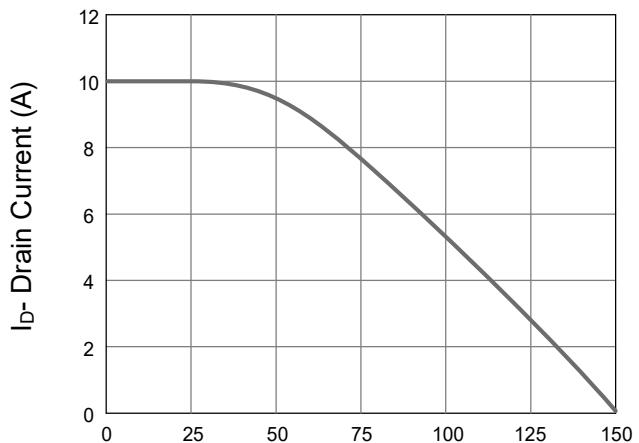


Figure 2 Switching Waveform



T_j-Junction Temperature (°C)
Figure 3 Power Dissipation



T_j-Junction Temperature (°C)
Figure 4 Drain Current

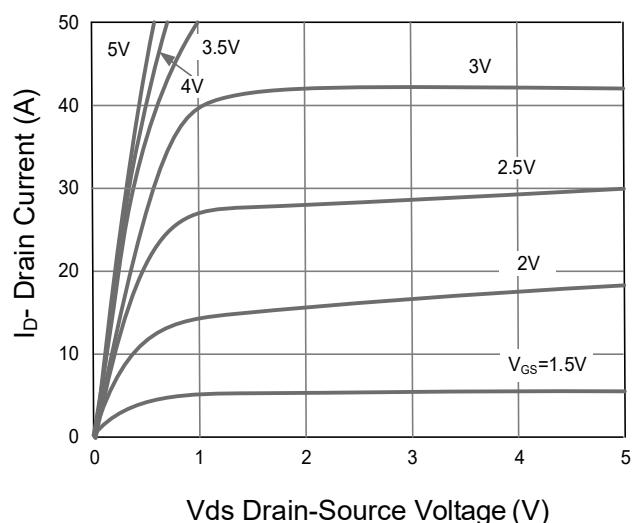


Figure 5 Output Characteristics

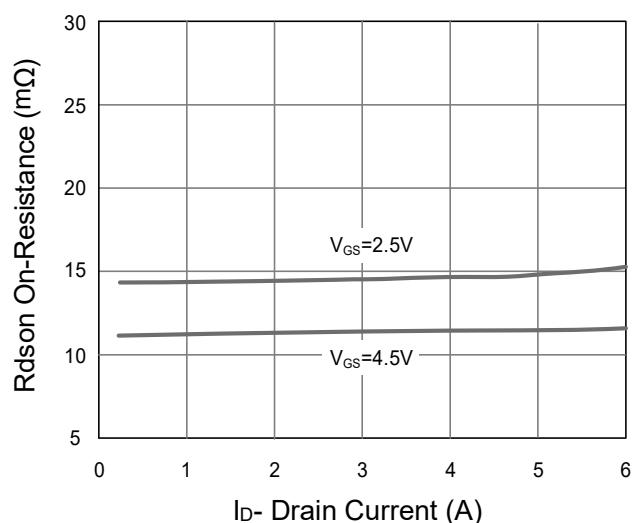


Figure 6 Rdson vs Drain Current

Ratings And Characteristic Curves

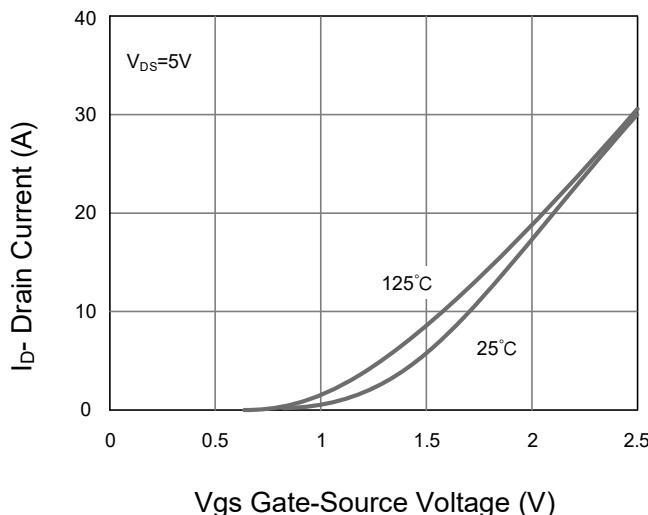


Figure 7 Transfer Characteristics

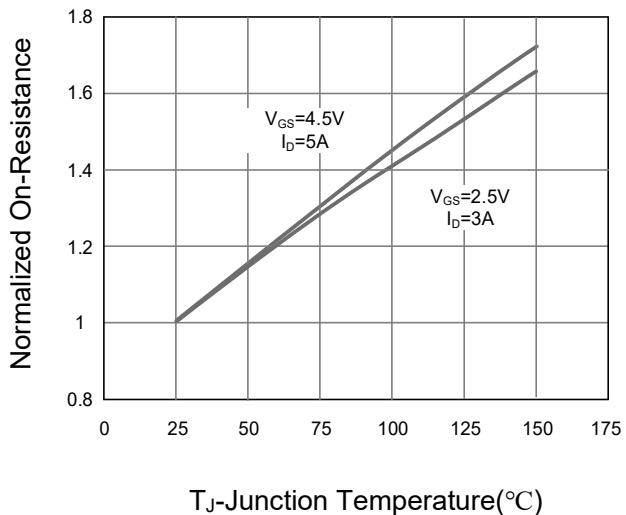


Figure 8 R_{DSON} vs Junction Temperature

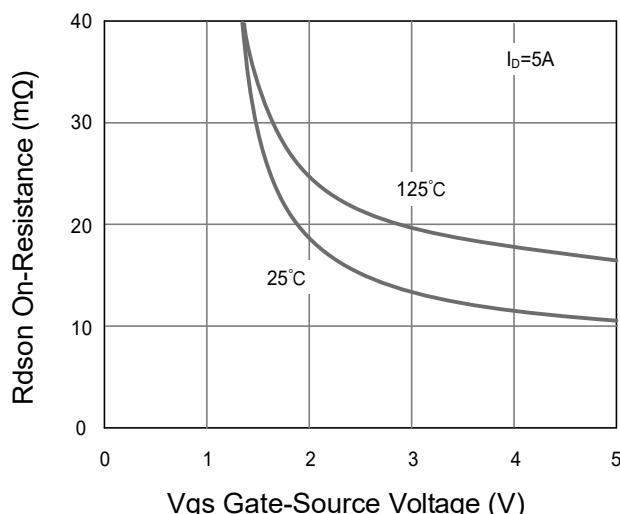


Figure 9 R_{DSON} vs V_{GS}

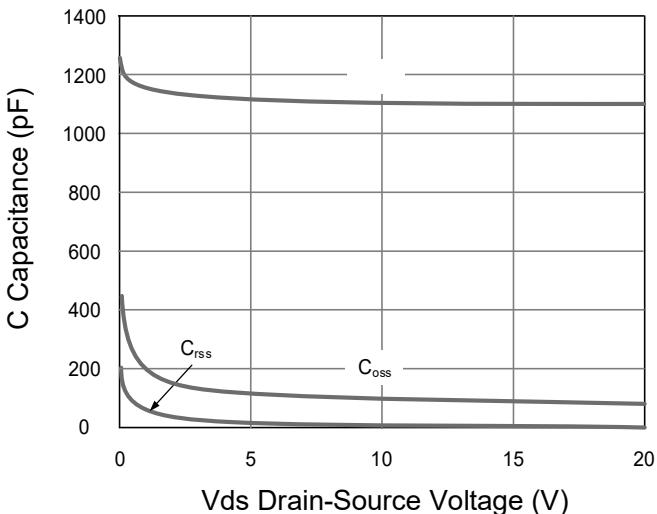


Figure 10 Capacitance vs V_{DS}

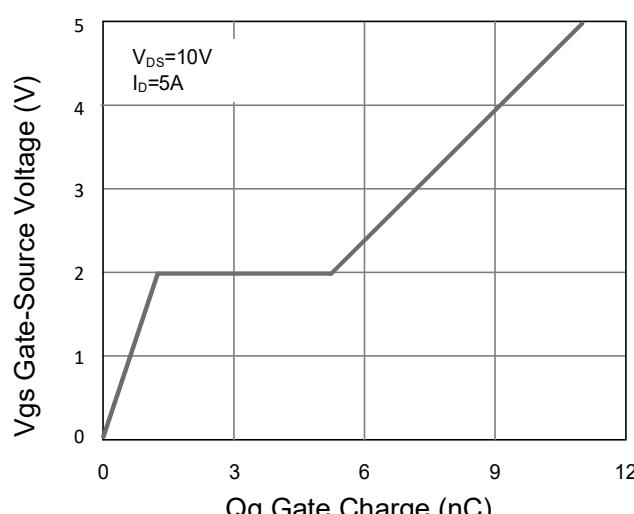


Figure 11 Gate Charge

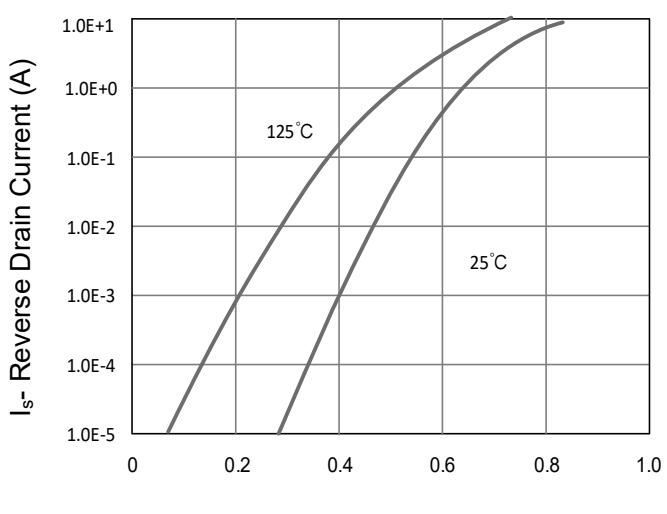


Figure 12 Source-Drain Diode Forward

Ratings And Characteristic Curves

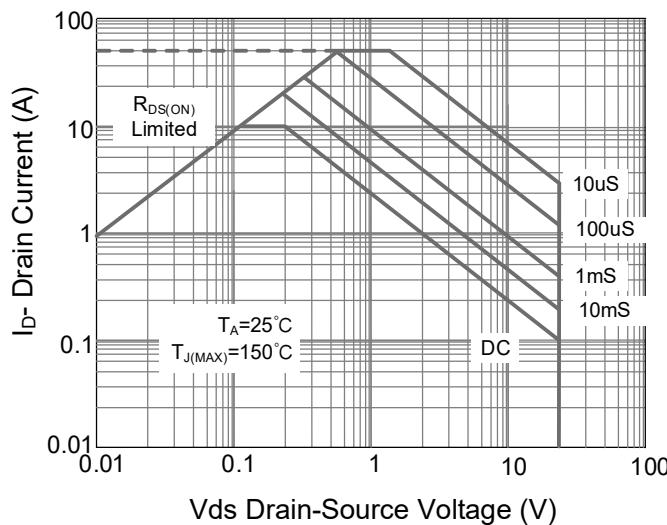


Figure 13 Safe Operation Area

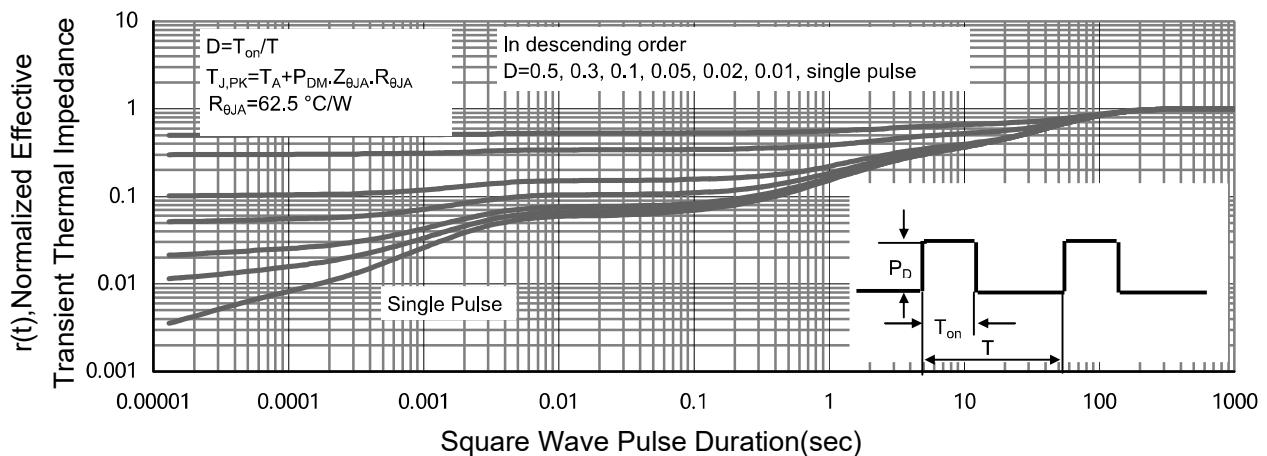


Figure 14 Normalized Maximum Transient Thermal Impedance

Ordering information

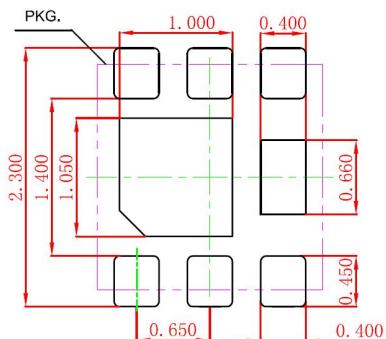
Package	Packing Description	Packing Quantity
DFN2*2-6L	Tape/Reel,13"reel	3000PCS/Reel 30000PCS/Carton

Package Dimensions

DFN2*2-6L

Dim.	Millimeter(mm)		mil	
	Min.	Max.	Min.	Max.
A	0.45	0.65	18	26
A1	0.00	0.05	-	2
b	0.25	0.35	10	14
c	0.155			
D	1.90	2.05	75	81
e	0.65			
E	1.90	2.05	75	81
E1	1.05	1.25	41	49
D1	0.85	1.05	34	41
L	0.25	0.35	10	14

The recommended mounting pad size Millimeter(mm)



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